


## Design Guide For High Density Flexible Circuits

Suitability of Metrigraphics High Density Flexible Circuitry	Applications requiring flexible microcircuitry not available from other sources.		
<b>Single Layer Circuits</b>  Applications: Invasive Medical Devices High Density Interconnects In-Vitro Diagnostics Environmental Sensors High Energy Measurement			
<b>Small Lot Array (Sheet)</b>	114.3 mm x 114.3 mm (4.5" x 4.5")		
<b>Production Lot Array (Sheet)</b>	254.0 x 254.0mm (10.0" x 10.0")		
<b>Minimum Trace/Space</b>	0.003 mm (0.00010")		
<b>Conductor Width/Thickness</b>	Minimum Width	Minimum Thickness	Maximum Thickness
Dependent on the minimum line/space ratio of the entire circuit.	0.003 mm (0.00010")	0.0005 mm (0.000019")	0.001 mm (.000039")
	0.005 mm (0.00019")	0.0010 mm (0.000039")	0.002 mm (0.00008")
	0.010 mm (0.00039")	0.0020 mm (0.000078")	0.005 mm (0.00019")
<b>Sheet Resistance of Plated Gold (Au) Conductors</b>	0.09 Ohms/Square at 0.0005 mm (0.000019") thickness 0.03 Ohms/Square at 0.0033 mm (0.00013") thickness		
<b>Substrate Materials (Typical)</b>	Dupont <b>Kapton®</b> Polyimide Film	Ube Industries <b>Upilex®S</b> Polyimide Film	HD Microsystems <b>PI 2611®</b> Cast Polyimide
<b>Thickness</b>	0.0076 mm - 0.125 mm (0.000299" - 0.0049")	0.0075 mm - 0.125 mm (0.000295" - 0.0049")	0.005 mm - 0.025 mm (0.00019" - 0.00098")
<b>Dielectric Constant</b>	3.9-4.0	3.2-3.5	3.2-3.5
<b>Coefficient of Thermal Expansion (CTE)</b>	20 ppm/°C	1.2-2.0x10 <sup>-5</sup> cm/cm/°C	2.9  3 ppm/°C
<b>Two-Layer Circuits</b>	All of the information above applies to 2-layer circuits, plus the information below:		
<b>Vias</b>	Recommended: 0.050 mm (0.0019"). Minimum via size: 0.025 mm (0.00098")		
<b>Dielectric Interlayers</b>	Arch Probimide®7000 - Dielectric Constant 3.3, CTE 27 ppm/°C HD Microsystems PI 2730® - Dielectric Constant 2.9, CTE 16 ppm/°C		
<b>Contacting Metrigraphics</b> metsales@drc.com	<b>Data Format</b> AutoCad or DXF files are preferred. Drawings should be in zero width chained polylines. Other formats may incur cost.	<b>Data Exchange</b> Data can be sent via E-Mail to: metsales@drc.com in zipped format or sent to the DRC FTP site.	